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SEMICONDUCTOR®

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FDPF390N15A N-Channel PowerTrench[®] MOSFET 150V, 15A, 40mΩ

Features

- $R_{DS(on)}$ = 31m Ω (Typ.)@ V_{GS} = 10V, I_D = 15A
- · Fast Switching Speed
- Low Gate Charge
- High Performance Trench Technology for Extremely Low $\mathsf{R}_{DS(\text{on})}$
- High Power and Current Handling Capability
- RoHS Compliant

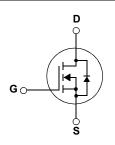
Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advance PowerTrench process that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

Application

- DC to DC Converters
- Synchronous Rectification for Server/Telecom PSU
- Battery Charger
- AC Motor Drives and Uninterruptible Power Supplies
- Off-line UPS





MOSFET Maximum Ratings $T_C = 25^{\circ}C$ unless otherwise noted

Symbol		Ratings	Units		
V _{DSS}	Drain to Source Voltage	150	V		
V _{GSS}	Gate to Source Voltage			±20	V
ID	Drain Current	-Continuous (T _C = 25 ^o C,Silico	15	— A	
		-Continuous (T _C = 100 ^o C,Silio	10		
I _{DM}	Drain Current	- Pulsed	(Note 1)	60	Α
E _{AS}	Single Pulsed Avalanche Ene	78	mJ		
dv/dt	Peak Diode Recovery dv/dt (Note 3)		6.0	V/ns	
P _D	Dewer Dissinction	(T _C = 25°C)		22	W
	Power Dissipation	- Derate above 25°C		0.18	W/ºC
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C
Τ _L	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C

Thermal Characteristics

Symbol	Parameter	Ratings	Units
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	5.7	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	62.5	C/W

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Device Marking		Device	Package		Reel Size Tap		e Width		Quantity		
FDPF390			TO-220	20F -			-		50		
Electrica	al Char	acteristics T _c =	25ºC unless	otherwise	noted						
Symbol		Parameter			Test Conditions		Min.	Тур.	Max.	Units	
Off Chara	cteristic	S									
BV _{DSS}	Drain to	Drain to Source Breakdown Voltage			I _D = 250μA, V _{GS} = 0V			-	-	V	
ΔBV _{DSS}	Breakdo	Breakdown Voltage Temperature		$I_{\rm D}$ = 250µA, Referenced to 25°C			0.1		V/ºC		
ΔT_{J}	Coeffici	Coefficient		2		-	0.1	-	- 0/*0		
I _{DSS}	Zero Gate Voltage Drain Current		$V_{DS} = 120V, V_{GS} = 0V$			-	-	1	μA		
				$V_{DS} = 120V, T_{C} = 125^{\circ}C$			-	-	500		
I _{GSS}	Gate to	Gate to Body Leakage Current			20V, V _{DS} = 0V		-	-	±100	nA	
On Chara	cteristic	S									
V _{GS(th)}	Gate Th	nreshold Voltage		V _{GS} = V	′ _{DS} , I _D = 250μA		2.0	-	4.0	V	
R _{DS(on)}	Static D	rain to Source On Resi	stance	V _{GS} = 1	0V, I _D = 15A		-	31	40	mΩ	
9 _{FS}	Forward	d Transconductance		V _{DS} = 10V, I _D = 15A (Note 4)			-	32	-	S	
Dynamic (Characte	prietics									
C _{iss}	-	apacitance					_	965	1285	pF	
C _{iss} C _{oss}		ut Capacitance ut Capacitance erse Transfer Capacitance		V _{DS} = 75V, V _{GS} = 0V f = 1MHz			-	905	1205	pr	
O _{oss} C _{rss}							_	5.8	-	pr	
C _{oss(er)}		Related Output Capacitance		V _{DS} = 75V,V _{GS} = 0V				169	-	pF	
Q _{g(tot)}		Gate Charge at 10V					-	14.3	18.6	nC	
Q _{gs}		Source Gate Charge		V _{DS} = 75V,I _D = 27A			5.0	-	nC		
Q _{gs2}		Charge Threshold to Plateau		V _{GS} = 10V			-	2.0	-	nC	
Q _{gd}	Gate to	Drain "Miller" Charge		_		(Note 4,5)	-	3.5	-	nC	
ESR	Equival	ent Series Resistance (G-S)	Drain Open,f = 1MHz			-	1.4	-	Ω	
0itahina	Charao	toviation			-						
Switching									00	1	
t _{d(on)}		Delay Time		$V_{DD} = 75V, I_D = 27A$ $V_{GS} = 10V, R_{GEN} = 4.7\Omega$ (Note 4,5)		-	14 10	38 30	ns		
t _r		n Rise Time f Delay Time				-	20	50	ns		
t _{d(off)}						(Noto 4 E)	-	-		ns	
t _f	Turn-Of	f Fall Time				(11018 4,3)	-	5	20	ns	
Drain-Sou	rce Dio	de Characteristics									
I _S		m Continuous Drain to		e Forward	Current		-	_	15	Α	
I _{SM}		m Pulsed Drain to Sour					-	_	60	A	
V _{SD}		to Source Diode Forward Voltage		$V_{GS} = 0V, I_{SD} = 15A$			-	-	1.25	V	
t _{rr}		Recovery Time		$V_{GS} = 0V, I_{SD} = 27A, V_{DD} = 75V$		-	63	-	ns		
Q _{rr}	Reverse	Recovery Charge		$dI_{\rm F}/dt = 100A/\mu s$ (Note 4)			-	131	-	nC	
2. Starting T _J = 25 3. I _{SD} ≤ 15A, di/dt 4. Pulse Test: Pul	5° C, L = 3 mH $c \leq 200$ A/µs, V _E se width ≤ 300	h limited by maximum junction , $I_{SD} = 7.2 A$ $_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}C$ μ s, Duty Cycle $\le 2\%$ perating Temperature Typical C	;								

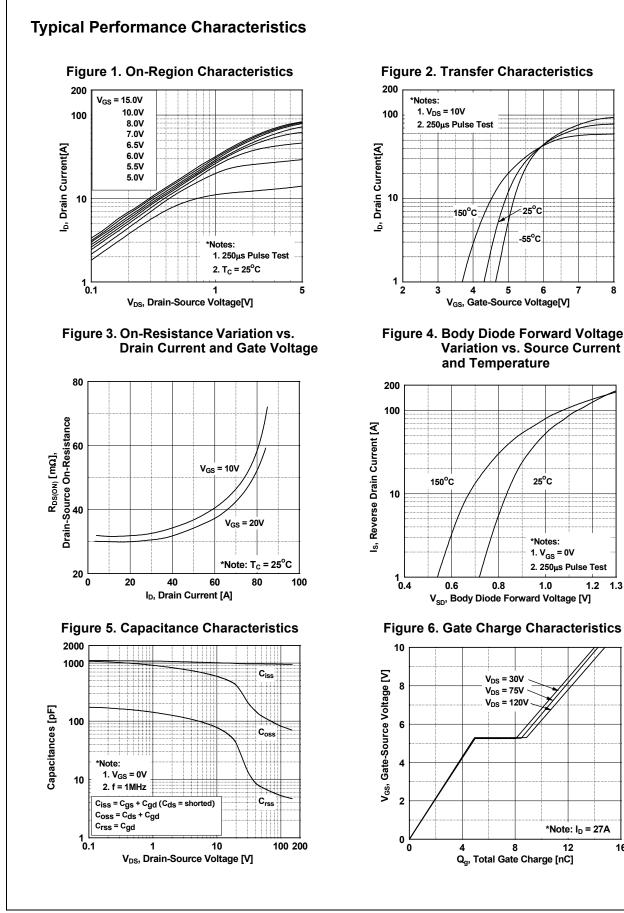
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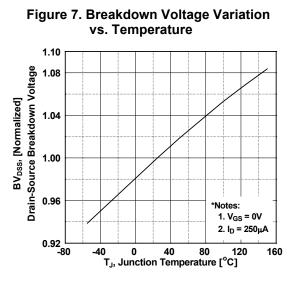


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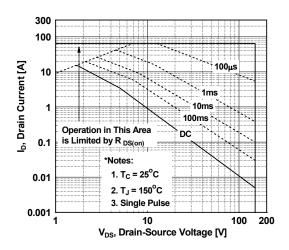
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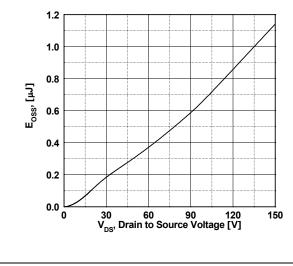












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Figure 8. On-Resistance Variation vs. Temperature 2.6 2.4 Drain-Source On-Resistance 80 71 91 07 89 07 R_{DS(on)}, [Normalized] Notes: 1. V_{GS} = 10V 2. I_D = 15A 0.4 └--80 -40 0 40 80 120 160 T_J, Junction Temperature [°C]

Figure 10. Maximum Drain Current vs. Case Temperature

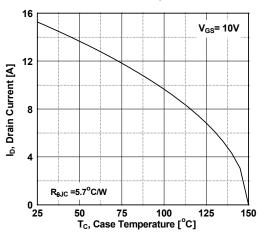
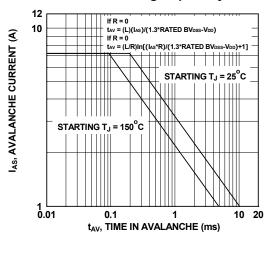
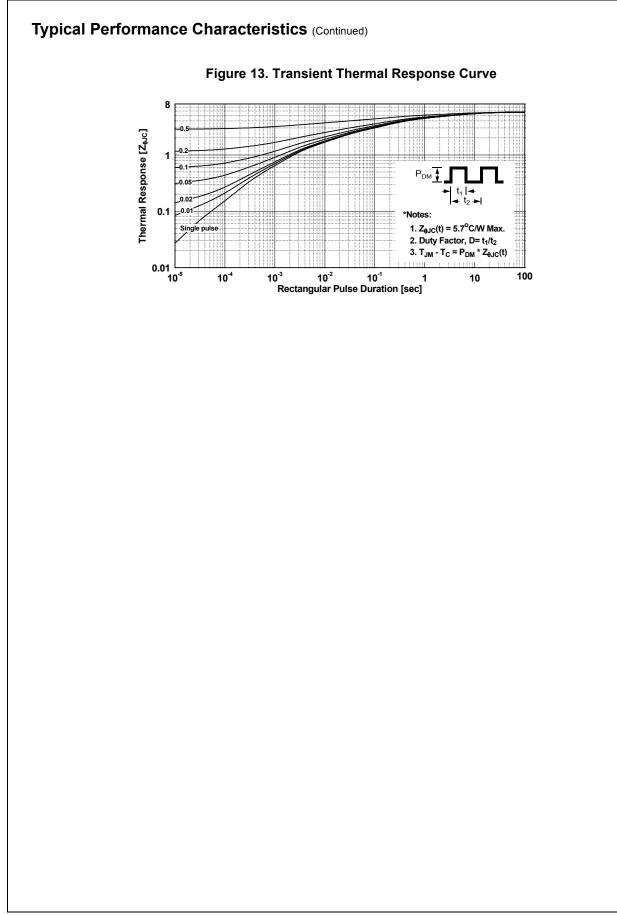
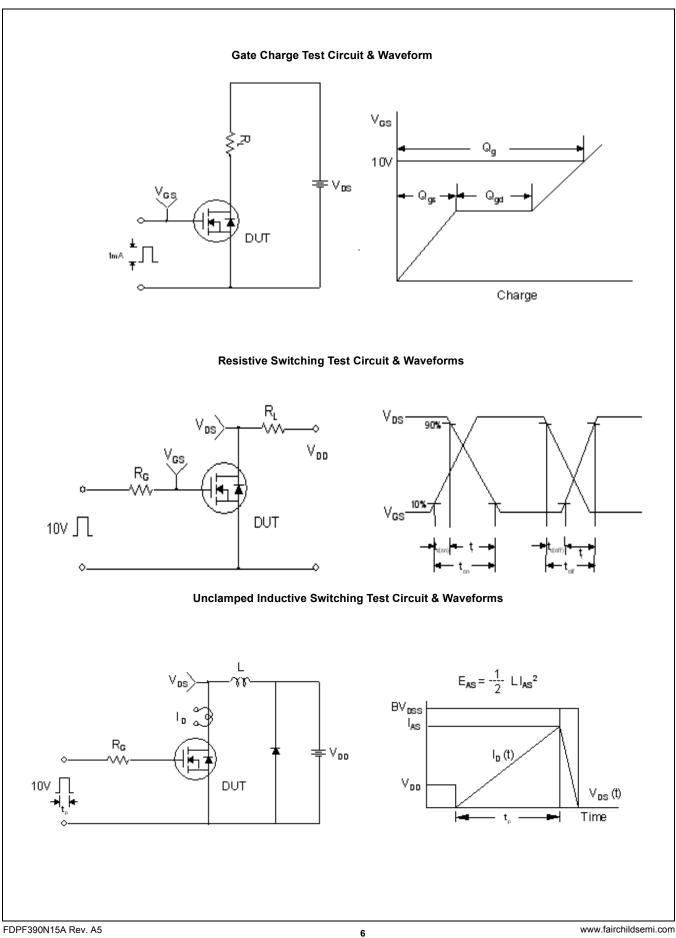


Figure 12. Unclamped Inductive Switching Capability

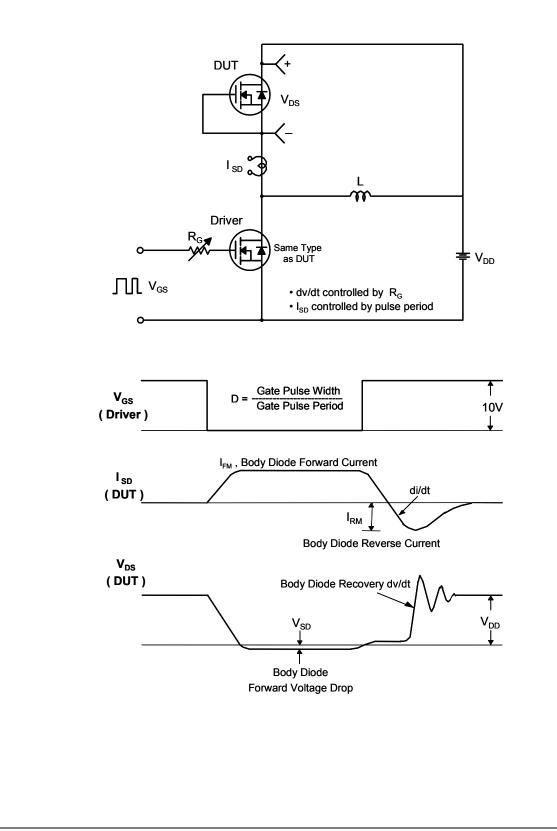




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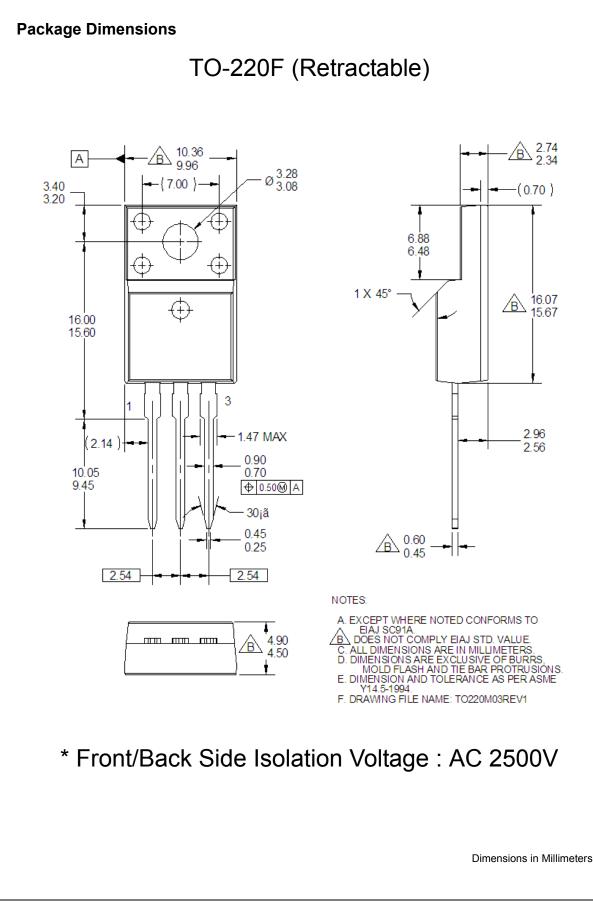


Peak Diode Recovery dv/dt Test Circuit & Waveforms



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